# M/XI/M

## Low-Cost, +2.7V to +5.5V, Micropower **Temperature Switches in SOT23 and TO-220**

### **General Description**

The MAX6501-MAX6504 low-cost, fully integrated temperature switches assert a logic signal when their die temperature crosses a factory-programmed threshold. Operating from a +2.7V to +5.5V supply, these devices feature two on-chip, temperature-dependent voltage references and a comparator. They are available with factory-trimmed temperature trip thresholds from -45°C to +115°C in 10°C increments, and are accurate to  $\pm 0.5^{\circ}C$  (typ) or  $\pm 6^{\circ}C$  (max). These devices require no external components and typically consume 30µA supply current. Hysteresis is pin-selectable at +2°C or +10°C.

The MAX6501/MAX6503 have an active-low, open-drain output intended to interface with a microprocessor ( $\mu P$ ) reset input. The MAX6502/MAX6504 have an activehigh, push-pull output intended to directly drive fancontrol logic. The MAX6501/MAX6502 are offered with hot-temperature thresholds (+35°C to +115°C), asserting when the temperature is above the threshold. The MAX6503/MAX6504 are offered with cold-temperature thresholds (-45°C to +15°C), asserting when the temperature is below the threshold.

The MAX6501-MAX6504 are offered in eight standard temperature versions; contact the factory for pricing and availability of nonstandard temperature versions. They are available in 5-pin SOT23 and 7-pin TO-220 packages.

**Typical Operating Circuit** 

### +2.7V T0 +5.5V Vcc Vcc MAXIM MAX6502 μΡ TOVER INT GND GND HYST GND

Selector Guide and Pin Configurations appear at end of data sheet.

<sup>†</sup>Patents Pending

M/X/M

Features

- ♦ ±0.5°C (typical) Threshold Accuracy Over **Full Temperature Range**
- No External Components Required
- Low Cost
- 30µA Supply Current
- Factory-Programmed Thresholds from -45°C to +115°C in 10°C Increments
- Open-Drain Output (MAX6501/MAX6503) Push-Pull Output (MAX6502/MAX6504)
- Pin-Selectable +2°C or +10°C Hysteresis
- SOT23-5 and TO220-7 Packages

	- •	
PART*	TEMP. RANGE	PIN-PACKAGE
MAX6501UKT	-55°C to +125°C	5 SOT23-5
MAX6501CMT	-55°C to +125°C	7 TO-220-7
MAX6502UKT	-55°C to +125°C	5 SOT23-5
MAX6502CMT	-55°C to +125°C	7 TO-220-7
MAX6503UKT	-55°C to +125°C	5 SOT23-5
MAX6503CMT	-55°C to +125°C	7 TO-220-7
MAX6504UKT	-55°C to +125°C	5 SOT23-5
MAX6504CMT	-55°C to +125°C	7 TO-220-7

**Ordering Information** 

\*These parts are offered in eight standard temperature versions with a minimum order of 2,500 pieces. To complete the suffix information, add P or N for positive or negative trip temperature, and select an available trip point in degrees centigrade. For example, the MAX6501UKP065-T describes a MAX6501 in a SOT23-5 package with a +65°C threshold. Contact the factory for pricing and availability of nonstandard temperature versions (minimum order 10,000 pieces).



Computers **Temperature Control Temperature Alarms** 

Fan Control

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### **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage (V <sub>CC</sub> )	0.3V to +7V
TOVER (MAX6501)	0.3V to +7V
TOVER (MAX6502)	
TUNDER (MAX6503)	0.3V to +7V
TUNDER (MAX6504)	0.3V to (Vcc + 0.3V)
All Other Pins	0.3V to (V <sub>CC</sub> + 0.3V)
Input Current (all pins)	20mÁ

Output Current (all pins)	20mA
Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )	
5-Pin SOT23-5 (derate 7.1mW/°C above +70°C)5	71mW
Operating Temperature Range55°C to +	125°C
Storage Temperature Range65°C to +	
Lead Temperature (soldering, 10sec)+	300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## **ELECTRICAL CHARACTERISTICS**

 $(V_{CC} = +2.7V \text{ to } +5.5V, R_{PULL-UP} = 100 \text{k}\Omega \text{ (MAX6501/MAX6503 only)}, T_A = T_{MIN} \text{ to } T_{MAX}, \text{ unless otherwise noted}. Typical values are at T_A = +25°C.) (Note 1)$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Supply Voltage Range	Vcc		2.7		5.5	V	
Supply Current	ICC			30	85	μA	
		-45°C to -25°C	-6	±0.5	6	°C	
Temperature Threshold	AT-11	-15°C to +15°C	-4	±0.5	4		
Accuracy (Note 2)	ΔT <sub>TH</sub>	+35°C to +65°C	-4	±0.5	4	C	
		+75°C to +115°C	-6	±0.5	6		
Temperature Threshold	Turrer	HYST = GND		2 10		°C	
Hysteresis	THYST	HYST = V <sub>CC</sub>					
HYST Input Threshold	Vih		0.8 x Vcc			V	
(Note 3)	VIL				0.2 x V <sub>CC</sub>	v	
Output Voltage High		ISOURCE = 500µA, V <sub>CC</sub> > 2.7V (MAX6502/MAX6504 only)	0.8 × V <sub>CC</sub> V <sub>CC</sub> - 1.5		V		
Output Voltage High	VOH	$I_{SOURCE} = 800\mu A, V_{CC} > 4.5V$ (MAX6502/MAX6504 only)					
	Vo	I <sub>SINK</sub> = 1.2mA, V <sub>CC</sub> > 2.7V	0.3		V		
Output Voltage Low	VOL	I <sub>SINK</sub> = 3.2mA, V <sub>CC</sub> > 4.5V	0.4				
Open-Drain Output Leakage Current		V <sub>CC</sub> = 2.7V, V <sub>TUNDER</sub> = 5.5V (MAX6503), V <sub>TOVER</sub> = 5.5V (MAX6501)		10		nA	

Note 1: 100% production tested at  $T_A = +25^{\circ}C$ . Specifications over temperature limits are guaranteed by design.

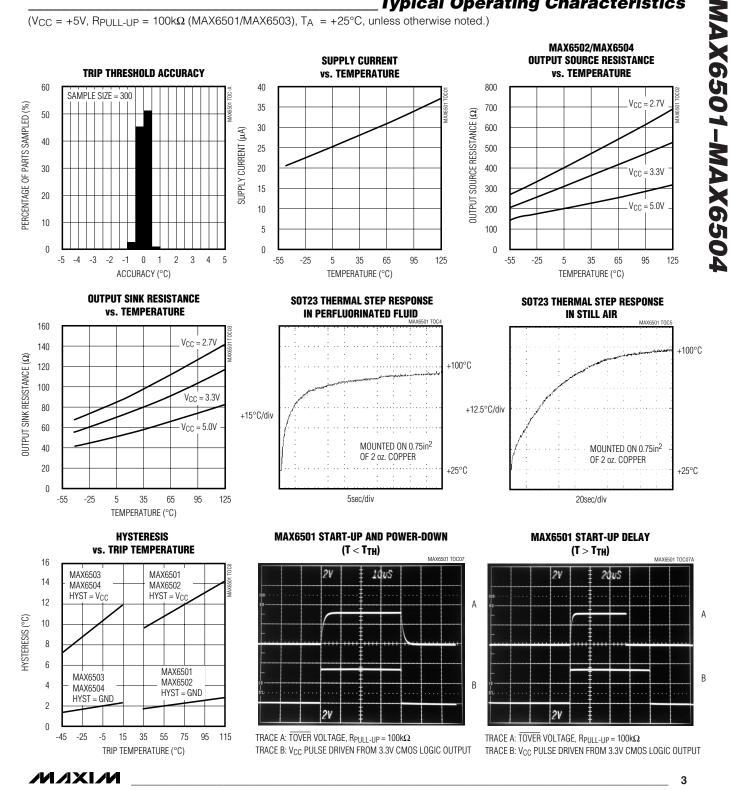
Note 2: The MAX6501–MAX6504 are available with internal, factory-programmed temperature trip thresholds from -45°C to +115°C in +10°C increments (see Selector Guide).

Note 3: Guaranteed by design.

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### Typical Operating Characteristics

 $(V_{CC} = +5V, R_{PULL-UP} = 100 k\Omega (MAX6501/MAX6503), T_A = +25^{\circ}C$ , unless otherwise noted.)



### Pin Description

	PIN			NAME	FUNCTION	
MAX6501	MAX6502	MAX6503	MAX6504		FUNCTION	
1, 2	1, 2	1, 2	1, 2	GND	Ground. Not internally connected. Tie both ground pins together close to the chip. Pin 2 provides the lowest thermal resistance to the die.	
3	3	3	3	HYST	Hysteresis Input. Connect HYST to GND for +2°C hysteresis, or connect to V <sub>CC</sub> for +10°C hysteresis.	
4	4	4	4	Vcc	Supply Input (+2.7V to +5.5V)	
5				TOVER	Open-Drain, Active-Low Output. TOVER goes low when the die temperature exceeds the factory-programmed temperature threshold. Connect to a 100k $\Omega$ pull-up resistor. May be pulled up to a voltage higher than V <sub>CC</sub> .	
	5			TOVER	Push-Pull Active-High Output. TOVER goes high when the die tem- perature exceeds the factory-programmed temperature threshold.	
		5		TUNDER	Open-Drain, Active-Low Output. TUNDER goes low when the die temperature goes below the factory-programmed temperature threshold. Connect to a 100k $\Omega$ pull-up resistor. May be pulled up to a voltage higher than V <sub>CC</sub> .	
		_	5	TUNDER	Push-Pull Active-High Output. TUNDER goes high when the die tem- perature falls below the factory-programmed temperature threshold.	

### **General Description**

The MAX6501–MAX6504 fully integrated temperature switches incorporate two temperature-dependent references and a comparator. One reference exhibits a positive temperature coefficient and the other a negative temperature coefficient (Figure 1). The temperature at which the two reference voltages are equal determines the temperature trip point. Pin-selectable +2°C or +10°C hysteresis keeps the output from oscillating when the die temperature approaches the threshold temperature. The MAX6501/MAX6503 have an active-low, open-drain output structure that can only sink current. The MAX6502/MAX6504 have an active-high, push-pull output structure that can sink or source current. The internal power-on reset circuit guarantees the output is at T<sub>TH</sub> = +25°C state at start-up for 50µs.

The MAX6501–MAX6504 are available with factorypreset temperature thresholds from -45°C to +115°C in 10°C increments. Table 1 lists the available temperature threshold ranges. The MAX6501/MAX6503 outputs are intended to interface with a microprocessor ( $\mu$ P) reset input (Figure 2). The MAX6502/MAX6504 outputs are intended for applications such as driving a fan control (Figure 3).

# Table 1. Factory-Programmed ThresholdRange

PART	THRESHOLD (TTH) RANGE
MAX6501	+35°C < T <sub>TH</sub> < +115°C
MAX6502	+35°C < T <sub>TH</sub> < +115°C
MAX6503	-45°C < T <sub>TH</sub> < +15°C
MAX6504	-45°C < T <sub>TH</sub> < +15°C

#### **Hysteresis Input**

The HYST pin is a CMOS-compatible input that selects hysteresis at either a high level ( $\pm 10^{\circ}$ C for HYST = V<sub>CC</sub>) or a low level ( $\pm 2^{\circ}$ C for HYST = GND). Hysteresis prevents the output from oscillating when the temperature approaches the trip point. The HYST pin should not float. Drive HYST close to ground or V<sub>CC</sub>. Other input voltages cause increased supply current. The actual amount of hysteresis depends on the part's programmed trip threshold. (See the *Typical Operating Characteristics* graphs.)



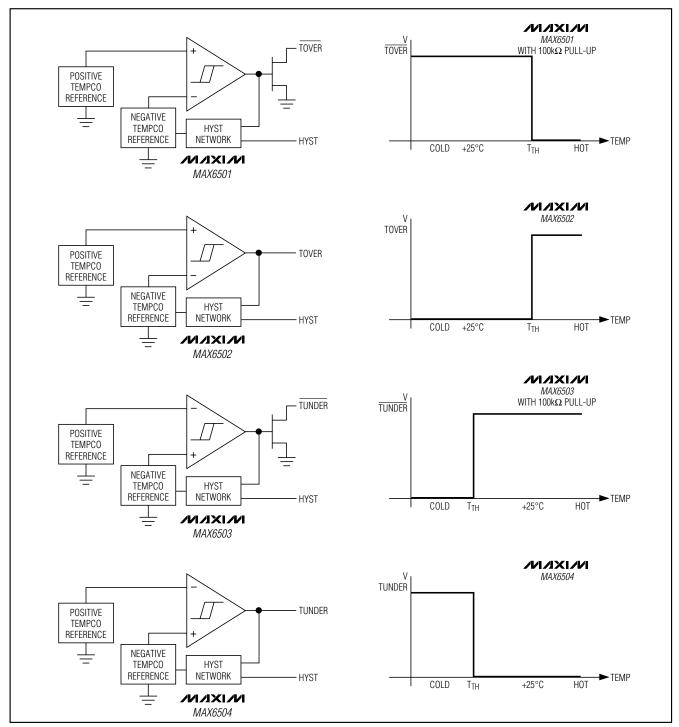


Figure 1. Block and Functional Diagrams

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MAX6501-MAX6504

MAX6501-MAX6504

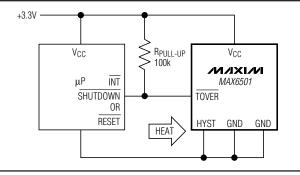


Figure 2. Microprocessor Alarm/Reset

## **Applications Information**

#### **Thermal Considerations**

The MAX6501–MAX6504 supply current is typically 30µA. When used to drive high-impedance loads, the devices dissipate negligible power. Therefore, the die temperature is essentially the same as the package temperature. The key to accurate temperature monitoring is good thermal contact between the MAX6501–MAX6504 package and the device being monitored. In some applications, the SOT23-5 package may be small enough to fit underneath a socketed µP, allowing the device to monitor the µP's temperature directly. The TO-220 package can monitor the temperature of a heat sink directly, and presents the lower thermal resistance of the two packages. Use the monitor's output to reset the µP, assert an interrupt, or trigger an external alarm.

Accurate temperature monitoring depends on the thermal resistance between the device being monitored and the MAX6501–MAX6504 die. Heat flows in and out of plastic packages, primarily through the leads. Pin 2 of the SOT23-5 package provides the lowest thermal resistance to the die. Short, wide copper traces leading to the temperature monitor ensure that heat transfers quickly and reliably.

The rise in die temperature due to self-heating is given by the following formula:

#### $\Delta T_J = P_{DISSIPATION} \times \theta_{JA}$

where PDISSIPATION is the power dissipated by the MAX6501–MAX6504, and  $\theta_{JA}$  is the package's thermal resistance.

The typical thermal resistance is 140°C/W for the SOT23-5 package and 75°C/W for the TO-220 package. To limit the effects of self-heating, minimize the output currents. For example, if the MAX6501 or MAX6503 sink 1mA, the output voltage is guaranteed to be less than 0.3V. Therefore, an additional 0.3mW of

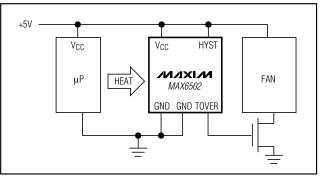


Figure 3. Overtemperature Fan Control

power is dissipated within the IC. This corresponds to a 0.042°C shift in the die temperature in the SOT23-5.

#### **Temperature-Window Alarm**

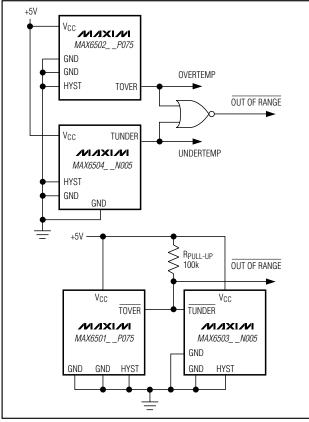
The MAX6501–MAX6504 temperature switch outputs assert when the die temperature is outside the factoryprogrammed range. Combining the outputs of two devices creates an over/undertemperature alarm. The MAX6501/MAX6503 and the MAX6502/MAX6504 are designed to form two complementary pairs, each containing one cold trip-point output and one hot trip-point output. The assertion of either output alerts the system to an out-of-range temperature. The MAX6502/MAX6504 push/pull output stages can be ORed to produce a thermal out-of-range alarm. More favorably, a MAX6501/ MAX6503 can be directly wire-ORed with a single external resistor to accomplish the same task (Figure 4).

The temperature window alarms shown in Figure 4 can be used to accurately determine when a device's temperature falls out of the -5°C to +75°C range. The thermal-overrange signal can be used to assert a thermal shutdown, power-up, recalibration, or other temperature-dependent function.

#### Low-Cost, Fail-Safe Temperature Monitor

In high-performance/high-reliability applications, multiple temperature monitoring is important. The high-level integration and low cost of the MAX6501–MAX6504 facilitate the use of multiple temperature monitors to increase system reliability. Figure 5's application uses two MAX6502s with different temperature thresholds to ensure that fault conditions that can overheat the monitored device cause no permanent damage. The first temperature exceeds +45°C. The second MAX6502 triggers a system shutdown if the die temperature reaches +75°C. The second temperature monitor's output asserts when a wide variety of destructive fault conditions occur, including latchups, short circuits, and cooling-system failures.





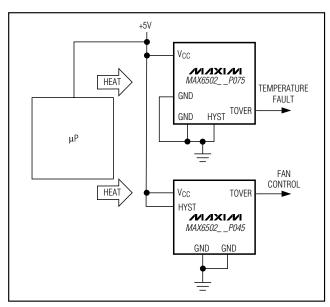


Figure 5. Low-Power, High-Reliability, Fail-Safe Temperature Monitor

Figure 4. Temperature-Window Alarms

#### Table 2. Device Marking Codes for SOT23-5 Package

DEVICE	CODE	MINIMUM ORDER
MAX6501UKP035	ABZF	10k
MAX6501UKP045	ABZR	2.5k
MAX6501UKP055	ACFW	2.5k
MAX6501UKP065	ABZS	2.5k
MAX6501UKP075	ACFV	2.5k
MAX6501UKP085	ACDP	2.5k
MAX6501UKP095	ABZT	2.5k
MAX6501UKP105	ACFU	10k
MAX6501UKP115	ACAG	2.5k
MAX6502UKP035	ABZG	10k
MAX6502UKP045	ABZU	2.5k
MAX6502UKP055	ACGC	2.5k
MAX6502UKP065	ABZV	2.5k
MAX6502UKP075	ACGB	2.5k
MAX6502UKP085	ACGA	2.5k
MAX6502UKP095	ABZW	2.5k

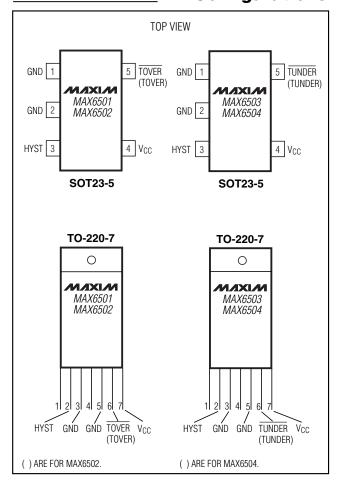
MINIMUM DEVICE CODE ORDER MAX6502UKP105 ACFZ 10k MAX6502UKP115 ACFY 2.5k MAX6503UKN045 ADIZ 10k MAX6503UKN035 ACAQ 10k MAX6503UKN025 ACAP 10k MAX6503UKN015 ACFX 2.5k MAX6503UKN005 ACAN 10k MAX6503UKP005 ABZX 2.5k MAX6503UKP015 ACAM 10k MAX6504UKN045 ACAX 10k MAX6504UKN035 ACAW 10k MAX6504UKN025 ACAV 10k MAX6504UKN015 ACGD 2.5k MAX6504UKN005 ACAT 10k MAX6504UKP005 ABZY 2.5k MAX6504UKP015 ADKE 10k

MAX6501-MAX6504

			3e	elector	Guide	
PART		MAX6501	AX6501 MAX6502 MAX6503		MAX6504	
OUTPUT STAGE		Open- Drain	Push-Pull	Pull Open- Drain Pu		
TRIP TEMP THRESHOLD		Hot	Hot	Cold	Cold	
_	-45			1	1	
်	-35			1	1	
DS	-25			1	1	
Р	-15			1	1	
HS	-5			1	1	
H	+5			1	1	
Ē	+15			1	1	
U.R.	+35	1	1			
3AT	+45	1	1			
Ш	+55	1	1			
EM	+65	1	1			
STANDARD TEMPERATURE THRESHOLDS (°C)	+75	1	1			
AR	+85	1	1			
	+95	1	1			
ST₽	+105	1	1			
	+115	1	1			

#### **Selector Guide**

\_Pin Configurations



### \_Chip Information

TRANSISTOR COUNT: 237 SUBSTRATE CONNECTED TO GND

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